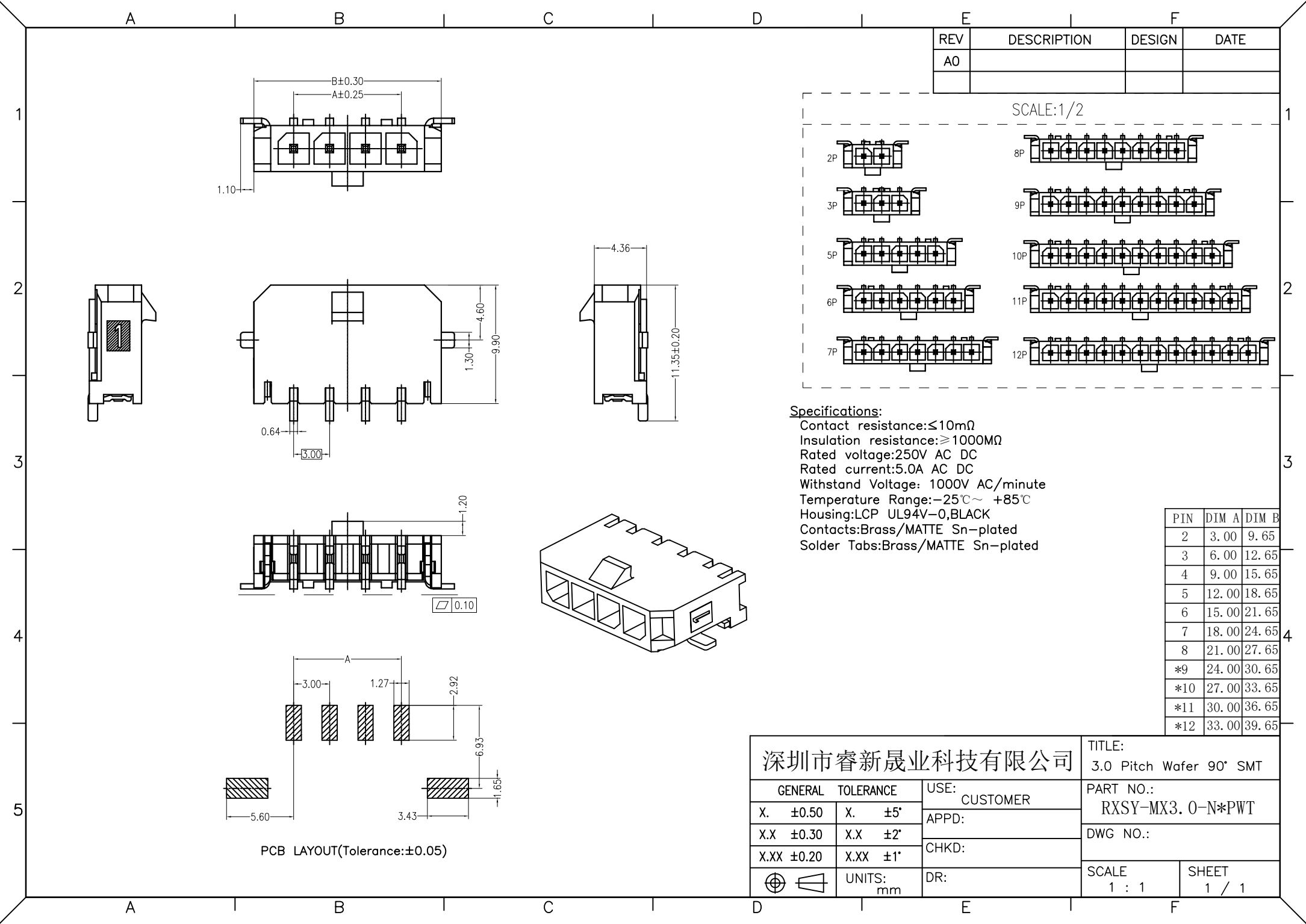
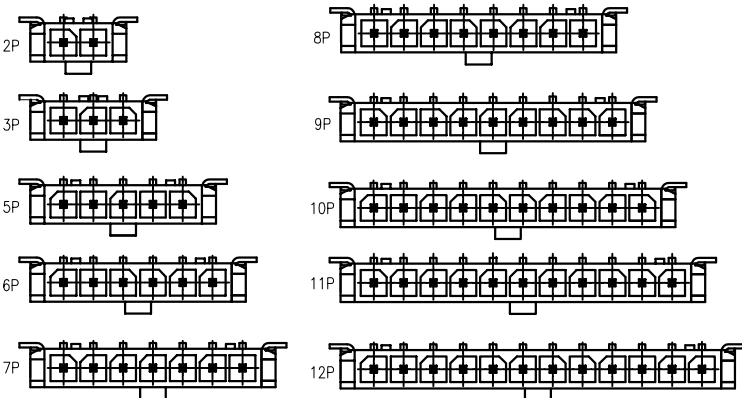




REV	DESCRIPTION	DESIGN	DATE
A0			

SCALE:1/2



Specifications:
Contact resistance:≤10mΩ
Insulation resistance:≥1000MΩ
Rated voltage:250V AC DC
Rated current:5.0A AC DC
Withstand Voltage: 1000V AC/minute
Temperature Range:−25℃~ +85℃
Housing:LCP UL94V−0,BLACK
Contacts:Brass/MATTE Sn−plated
Solder Tabs:Brass/MATTE Sn−plated

PIN	DIM A	DIM B
2	3.00	9.65
3	6.00	12.65
4	9.00	15.65
5	12.00	18.65
6	15.00	21.65
7	18.00	24.65
8	21.00	27.65
*9	24.00	30.65
*10	27.00	33.65
*11	30.00	36.65
*12	33.00	39.65

深圳市睿新晟业科技有限公司			TITLE: 3.0 Pitch Wafer 90° SMT	
GENERAL TOLERANCE		USE: CUSTOMER	PART NO.: RXSY-MX3.0-N*PWT	
X. ±0.50	X. ±5°		DWG NO.:	
X.X ±0.30	X.X ±2°	APPD:	SCALE 1 : 1	
X.XX ±0.20	X.XX ±1°	CHKD:		
UNITS: mm		DR:	SHEET 1 / 1	